

TECHNICAL UNIVERSITY OF KOŠICE

Faculty of Electrical Engineering and Informatics

Department of Electronics and Multimedia Communications

MASTER'S THESIS

**Conception of Connection of Embedded  
Processor to Arithmetic Coprocessor  
in SOPC Altera**

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# Confirmation

Hereby I confirm that I have completed this Master's thesis by myself and all literature is cited.

In Košice May 6, 2002

.....  
signature

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# Abstract

It is widely recognized that security issues will play a crucial role in future computer and communication systems. A central tool for achieving system security are cryptographic algorithms. For performance as well as for physical security reasons it is often required to realize cryptographic algorithms in hardware. This contribution proposes connection of arithmetic architecture – a scalable Montgomery multiplication (MM) coprocessor which is optimized for Altera programmable logic devices (PLD) to the Nios embedded processor.

We show the procedure of how the coprocessor, and the whole block are synthesized and simulated. Special attention we pay to the description of Nios Avalon Bus, its features and selected parameters of connection. Various configurations of the coprocessor together with timing analysis results and area estimations for Altera devices are presented.

# Contents

Abbreviations	vi
Symbols	viii
<b>1 Introduction</b>	<b>1</b>
1.1 Thesis motivation . . . . .	1
1.2 Thesis overview . . . . .	2
<b>2 Preliminaries: RSA Algorithm</b>	<b>3</b>
2.1 RSA . . . . .	3
2.2 Montgomery Multiplication Algorithm . . . . .	4
2.3 Radix-2 Montgomery Multiplication . . . . .	4
2.4 High-Radix Montgomery Multiplication . . . . .	5
<b>3 Preliminaries: Software&amp;Hardware Tools</b>	<b>7</b>
3.1 Nios system . . . . .	7
3.1.1 Nios processor . . . . .	7
3.1.2 Avalon Bus . . . . .	8
3.2 SOPC Builder . . . . .	9
3.3 Interfacing user-defined peripheral to SOPC builder . . . . .	10
3.3.1 PTF File . . . . .	11
3.4 Software tools . . . . .	12
3.4.1 Quartus . . . . .	12
3.4.2 ModelSim . . . . .	13
3.4.3 LeonardoSpectrum . . . . .	13
3.4.4 GNUPro Software Development Tool . . . . .	14
3.5 Development board . . . . .	14
3.5.1 GERMS monitor . . . . .	14
3.5.2 APEX 20K200EFC484-2X device . . . . .	15
<b>4 Radix-2 Coprocessor Implementation</b>	<b>17</b>
4.1 Design considerations . . . . .	17
4.1.1 MM coprocessor . . . . .	17
4.1.2 Interface . . . . .	18

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4.1.3	Address alignment . . . . .	19
4.2	Multiplier block . . . . .	20
4.2.1	Design 1 . . . . .	21
4.2.2	Design 2 . . . . .	21
4.2.3	Parallel computation . . . . .	21
4.2.4	MM unit . . . . .	22
4.2.5	State machine . . . . .	23
4.2.6	Memory control signals . . . . .	23
4.2.7	Counters . . . . .	24
4.3	Memory block . . . . .	24
4.4	Interface block . . . . .	26
4.5	Testing software . . . . .	27
4.5.1	RSA . . . . .	28
<b>5</b>	<b>Methodology</b>	<b>29</b>
5.1	Code translation . . . . .	29
5.2	Simulation . . . . .	29
5.2.1	The MM coprocessor simulation . . . . .	30
5.2.2	The Nios processor simulation . . . . .	31
5.3	Synthesis . . . . .	32
<b>6</b>	<b>Results and comparisons</b>	<b>34</b>
6.1	Design 1 . . . . .	34
6.2	Design 1a . . . . .	36
6.3	Comparison of Design 1 and Design 1a . . . . .	37
6.4	Design 2 . . . . .	38
6.5	Design 2a . . . . .	39
6.6	Comparison of Design 2 and Design 2a . . . . .	39
6.7	Comparison of Design 1 and Design 2 . . . . .	41
6.8	Computation time . . . . .	41
6.9	ESB occupation . . . . .	42
6.10	Application to RSA . . . . .	43
6.11	Comparison to solution with embedded PIC processor . . . . .	44
<b>7</b>	<b>Conclusion</b>	<b>46</b>
	<b>Bibliography</b>	<b>47</b>

# List of Figures

3.1	Block diagram of the Nios system . . . . .	8
3.2	APEX 20K ESB Implementing Dual-Port RAM . . . . .	16
4.1	Block diagram of MM coprocessor . . . . .	18
4.2	Block diagram of the interface between the MM coprocessor and the Nios processor . . . . .	18
4.3	Block diagram of multiplier data path . . . . .	21
4.4	Structure of MM unit for $w = 3$ (FA – Full Adder) . . . . .	22

# List of Tables

3.1	Nios CPU architecture . . . . .	8
3.2	GERMS monitor commands . . . . .	15
3.3	APEX20K200E device features . . . . .	15
6.1	Design 1 – Area occupation (LEs)/max $f_{clk}$ (MHz) of the MM coprocessor ( $k = 1024$ bits) . . . . .	34
6.2	Design 1 – Area occupation (LEs)/max $f_{clk}$ (MHz) of the MM coprocessor ( $k = 2048$ bits) . . . . .	35
6.3	Design 1 – Area occupation (LEs)/max $f_{clk}$ (MHz) of the MM coprocessor ( $k = 4096$ bits) . . . . .	35
6.4	Design 1a – Area occupation (LEs)/max $f_{clk}$ (MHz) of the MM coprocessor ( $k = 1024$ bits) . . . . .	36
6.5	Design 1a – Area occupation (LEs)/max $f_{clk}$ (MHz) of the MM coprocessor ( $k = 2048$ bits) . . . . .	36
6.6	Design 1a – Area occupation (LEs)/max $f_{clk}$ (MHz) of the MM coprocessor ( $k = 4096$ bits) . . . . .	36
6.7	Comparison of max $f_{clk}$ (MHz) for Design 1 and Design 1a ( $k = 1024$ bits) . . . . .	37
6.8	Comparison of max $f_{clk}$ (MHz) for Design 1 and Design 1a ( $k = 2048$ bits) . . . . .	37
6.9	Comparison of max $f_{clk}$ (MHz) for Design 1 and Design 1a ( $k = 4096$ bits) . . . . .	37
6.10	Design 2 – Area occupation (LEs)/max $f_{clk}$ (MHz) of the MM coprocessor ( $k = 1024$ bits) . . . . .	38
6.11	Design 2 – Area occupation (LEs)/max $f_{clk}$ (MHz) of the MM coprocessor ( $k = 2048$ bits) . . . . .	38
6.12	Design 2 – Area occupation (LEs)/max $f_{clk}$ (MHz) of the MM coprocessor ( $k = 4096$ bits) . . . . .	38
6.13	Design 2a – Area occupation (LEs)/max $f_{clk}$ (MHz) of the MM coprocessor ( $k = 1024$ bits) . . . . .	39
6.14	Design 2a – Area occupation (LEs)/max $f_{clk}$ (MHz) of the MM coprocessor ( $k = 2048$ bits) . . . . .	39

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6.15	Design 2a – Area occupation (LEs)/max $f_{clk}$ (MHz) of the MM co-processor ( $k = 4096$ bits) . . . . .	39
6.16	Comparison of max $f_{clk}$ (MHz) for Design 2 and Design 2a ( $k = 1024$ bits) . . . . .	40
6.17	Comparison of max $f_{clk}$ (MHz) for Design 2 and Design 2a ( $k = 2048$ bits) . . . . .	40
6.18	Comparison of max $f_{clk}$ (MHz) for Design 2 and Design 2a ( $k = 4096$ bits) . . . . .	40
6.19	Comparison of area occupation (LEs)/max $f_{clk}$ (MHz) for Design 1 and Design 2 ( $k = 1024$ bits) . . . . .	41
6.20	Comparison of area occupation (LEs)/max $f_{clk}$ (MHz) for Design 1 and Design 2 ( $k = 2048$ bits) . . . . .	41
6.21	Comparison of area occupation (LEs)/max $f_{clk}$ (MHz) for Design 1 and Design 2 ( $k = 4096$ bits) . . . . .	42
6.22	Speed of MM operation for $w = 32$ . . . . .	42
6.23	Number of used ESBs . . . . .	42
6.24	Application to RSA: encryption and decryption for $w = 16$ , $k = 1024$ , $f_{clk} = 33.333$ MHz . . . . .	43
6.25	Application to RSA: encryption and decryption for $w = 8$ , $k = 1024$ , $f_{clk} = 33.333$ MHz . . . . .	43
6.26	Occupied sources by 16-bit Nios processor . . . . .	44
6.27	Area occupation for EP20K100 device . . . . .	44

# Abbreviations

<b>AHDL</b>	ALTERA HARDWARE DESCRIPTION LANGUAGE
<b>CPU</b>	CENTRAL PROCESSING UNIT
<b>CR</b>	CARRIAGE RETURN
<b>DSS</b>	DIGITAL SIGNATURE STANDARD
<b>DUT</b>	DESIGN UNDER TEST
<b>ECC</b>	ELLIPTIC CURVE CRYPTOGRAPHY
<b>EDIF</b>	ELECTRONIC DESIGN INTERCHANGE FORMAT
<b>ESB</b>	EMBEDDED SYSTEM BLOCK
<b>FA</b>	FULL ADDER
<b>GCD</b>	GREATEST COMMON DIVISOR
<b>GDB</b>	GNUPRO DEBUGGER
<b>GERMS</b>	GO, ERASE, RELOCATE, MEMORY SET AND DUMP, SEND MONITOR
<b>GUI</b>	GRAPHICAL USER INTERFACE
<b>HDL</b>	HARDWARE DESCRIPTION LANGUAGE
<b>HDK</b>	HARDWARE DEVELOPMENT KIT
<b>HW</b>	HARDWARE
<b>IP</b>	INTELLECTUAL PROPERTY
<b>ITU</b>	INTERNATIONAL TELECOMMUNICATIONS UNION
<b>I/O</b>	INPUT/OUTPUT
<b>JTAG</b>	JOIN TEST ACTION GROUP
<b>LE</b>	LOGIC ELEMENT
<b>LF</b>	LINE FEED
<b>LSB</b>	LEAST SIGNIFICANT BIT
<b>LSB</b>	LIBRARY OF PARAMETERIZED MODULES
<b>MHz</b>	MEGAHERTZ
<b>MIF</b>	MEMORY INITIALIZATION FILE
<b>MM</b>	MONTGOMERY MULTIPLICATION
<b>MSB</b>	MOST SIGNIFICANT BIT
<b>MWR2MM</b>	MULTIPLE WORD RADIX-2 MONTGOMERY MULTIPLICATION
<b>MWR2<sup>m</sup>MM</b>	MULTIPLE WORD HIGH-RADIX ( $2^m$ ) MONTGOMERY MULTIPLICATION
<b>N/A</b>	NOT AVAILABLE

---

<b>PBM</b>	PERIPHERAL BUS MODULE
<b>PCI</b>	PERIPHERAL COMPONENT INTERCONNECT
<b>PIO</b>	PARALLEL INPUT/OUTPUT
<b>PLD</b>	PROGRAMMABLE LOGIC DEVICE
<b>PTF</b>	PERIPHERAL TEMPLATE FILE
<b>P&amp;R</b>	PLACE&ROUTE
<b>RAM</b>	RANDOM ACCESS MEMORY
<b>RISC</b>	REDUCED INSTRUCTION SET COMPUTER
<b>ROM</b>	READ-ONLY MEMORY
<b>RSA</b>	RIVEST, SHAMIR, AND ADLEMAN
<b>SDK</b>	SOFTWARE DEVELOPMENT KIT
<b>SOPC</b>	SYSTEM ON A PROGRAMMABLE CHIP
<b>SRAM</b>	STATIC RAM
<b>SREC</b>	S-RECORD FILE FORMAT
<b>SW</b>	SOFTWARE
<b>UART</b>	UNIVERSAL ASYNCHRONOUS RECEIVER/TRANSMITTER
<b>VHDL</b>	VHSIC HARDWARE DESCRIPTION LANGUAGE
<b>VHSIC</b>	VERY HIGH SPEED INTEGRATED CIRCUIT

# Symbols

$w$	word width
$e$	number of words
$k$	length of operands
$r$	radix of the computation
$X$	multiplier
$Y$	multiplicand
$M$	modulus
$S$	partial sum
$A^{(x)}$	the $x^{\text{th}}$ word of vector $A$
$b_y$	the $y^{\text{th}}$ bit of vector $B$
$(A, B)$	concatenation of vectors $A$ and $B$
$A_{x..y}$	particular range of bits in a vector $A$ from position $x$ to position $y$
$A_x^{(y)}$	bit position of the $y^{\text{th}}$ word of $A$
${}_x A$	the $x^{\text{th}}$ part of vector $A$
$\lceil a \rceil$	the smallest integer greater than or equal to $a$ (ceiling)
$a \mid b$	$a$ divides $b$

# Chapter 1

## Introduction

*While the Internet creates a new cyberspace separate from our physical world, technological advances will enable ubiquitous networked computing in our day-to-day lives. The power of this ubiquity will follow from the embedding of computation and communications in the physical world – that is, embedded devices with sensing and communication capabilities that enable distributed computation.[20]*

It is widely recognized that security issues will play a crucial role in many future computer and communication systems. A central tool for achieving system security is cryptography. For performance as well as for physical security reasons it is often required to realize cryptographic algorithms in hardware. The ASIC implementation have the drawback of low flexibility compared to software solutions. By coming of modern security protocols a high degree of flexibility with respect to the cryptographic algorithms is desirable. The implementation of cryptographic algorithms in reconfigurable devices offers high flexibility and physical security of traditional hardware. In this thesis we deal with implementation of arithmetic architecture – a scalable MM coprocessor for modular exponentiation with very long integers and with connection of this coprocessor to the Nios embedded processor.

Several applications, such as RSA algorithm [37], Diffie-Hellman key exchange algorithm [17], Digital Signature Standard (DSS) [26], and Elliptic curve cryptography (ECC) [30] use modular multiplication and modular exponentiation. The MM algorithm provides certain advantages in the implementation of modular multiplication with very long integers. The precision varies from 128 and 256 bits for elliptic curve cryptography to 1024 and 2048 bits or even more for applications based on exponentiation.

### 1.1 Thesis motivation

Main reason why the MM coprocessor is implemented is the need for obtaining as fast solution as possible. When we compare software and hardware implementation,

we see that software implementation in embedded systems is very slow and unusable in real applications [27].

On the other hand many solutions in hardware were presented in publications. Disadvantage of these implementations is the fixed length of operands [38]. In our case very flexible solution is implemented and the operands' length is not limited. Implementation in PLD allows the designer to prepare application suitable for a customer in very short time.

The connection of the coprocessor to the Nios processor will make possible to develop more difficult software application than it has been possible by using the PIC processor [25].

## 1.2 Thesis overview

The assignment of this thesis consists of these tasks:

1. Analyze the possibilities of connection of arithmetic coprocessor to Nios embedded processor from Altera.
2. Verify the suggested solution using the existing MM coprocessor for modular multiplication.
3. Compare obtained results with existing solution based on embedded processor PIC from Microchip.

Thesis consists of seven chapters. In chapter Introduction the motivation and overview of thesis is given. Second chapter briefly describes implemented algorithms. Next chapter is introducing the software and hardware tools used during development and testing. Chapter 4 is describing the MM coprocessor implementation and connection to the Nios processor in details. In Chapter 5 the methodology of simulation and synthesis is mentioned. In Chapter 6 the results of implementations are discussed and the last chapter conveys the conclusions of the whole thesis.

# Chapter 2

## Preliminaries: RSA Algorithm and Modular Exponentiation

In this chapter we review RSA as one of the public key algorithms. We mention speed-up methods for Montgomery modular multiplication proposed in the literature, which are well suited for hardware implementations.

### 2.1 RSA

RSA was proposed by Rivest, Shamir, and Adleman in 1978 [37]. The private key of a user consists of two large primes  $p$  and  $q$  and a secret exponent  $D$ . The public key consists of the modulus

$$M = pq \tag{2.1}$$

and an exponent  $E$  such that  $E$  satisfies:

$$\text{GCD}(E, (p-1)(q-1)) = 1 \tag{2.2}$$

Secret key  $D$  is chosen such that:

$$D = E^{-1} \text{ mod } (p-1)(q-1) \tag{2.3}$$

The security of the system rests in part on the difficulty of factoring the published divisor,  $M$ .

Basic mathematical operation used by RSA to encrypt a message  $X$  is modular exponentiation [33]:

$$Y = X^E \text{ mod } M \tag{2.4}$$

that a binary or general  $m$ -nary methods can break into a series of modular multiplications.

Decryption is done by calculating:

$$X = Y^D \text{ mod } M \tag{2.5}$$

All of these computations have to be performed with large  $k$ -bit integers (typical  $k \in \{1024, 2048, \dots\}$ ) in order to thwart currently known attacks.

For speeding up encryption the use of a short exponent  $E$  has been proposed. Recommended by the International Telecommunications Union (ITU) is the Fermat prime  $F_4 = 2^{2^4} + 1$ . Using  $F_4$ , the encryption is executed in only 17 operations.

Obviously the same trick can not be used for decryption, as the decryption exponent  $D$  must be kept secret.

## 2.2 Montgomery Multiplication Algorithm

The well-known MM algorithm [32] speeds-up modular multiplication and squaring required for exponentiation (2.4) and (2.5). It computes the MM product for  $k$ -bit integers  $X, Y$

$$MM(X, Y) = XYR^{-1} \bmod M \quad (2.6)$$

where  $R = 2^k$  and  $M$  is an integer in the range  $2^{k-1} < M < 2^k$  such that  $\text{GCD}(R, M) = 1$ .

Basic MM (2.6) can be used for efficient computation of (2.4) and (2.5) by the standard Montgomery exponentiation algorithm [33] ( $E = (e_{t-1}, \dots, e_0)_2$ , with  $e_{t-1} = 1$ , all other variables are  $k$ -bit integers).

- 1:  $\widetilde{X} = MM(X, R^2 \bmod M) = XR \bmod M$
- 2:  $A = R \bmod M$
- 3: **for**  $i = t - 1$  **down to** 0 **do**
- 4:    $A = MM(A, A)$
- 5:   **if**  $e_i = 1$  **then**
- 6:      $A = MM(A, \widetilde{X})$
- 7:  $A = MM(A, 1)$

Algorithm 2.1: Montgomery exponentiation

The starting point of Algorithm 2.1 is MM. The faster the MM is performed, the faster the exponentiation process will be accomplished.

## 2.3 Radix-2 Montgomery Multiplication

In [39] the Multiple Word Radix-2 Montgomery Multiplication (MWR2MM) algorithm with word length  $w$  is described. MWR2MM performs bit-level computations, produces word-level outputs and provides direct support for scalable MM coprocessor design. For operands with a  $k$ -bit precision  $e = \lceil k/w \rceil$  words are required.

MWR2MM algorithm scans word-wise operand  $Y$  (multiplicand), and bit-wise operand  $X$  (multiplier), so it uses vectors

$$M = (M^{(e-1)}, \dots, M^{(1)}, M^{(0)})$$

$$\begin{aligned}
Y &= (Y^{(e-1)}, \dots, Y^{(1)}, Y^{(0)}) \\
X &= (x_{k-1}, \dots, x_1, x_0)
\end{aligned} \tag{2.7}$$

where words are marked with superscripts and bits are marked with subscripts. MWR2MM algorithm is described in Algorithm 2.2.

```

1:  $S = 0$ 
2: for  $i = 0$  to  $k - 1$  do
3:    $C = 0$ 
4:    $(C, S^{(0)}) = x_i Y^{(0)} + S^{(0)}$ 
5:   if  $S_0^{(0)} = 1$  then
6:      $(C, S^{(0)}) = C + S^{(0)} + M^{(0)}$ 
7:     for  $j = 1$  to  $e - 1$  do
8:        $(C, S^{(j)}) = C + x_i Y^{(j)} + M^{(j)} + S^{(j)}$ 
9:        $S^{(j-1)} = (S_0^{(j)}, S_{w-1..1}^{(j-1)})$ 
10:     $S^{(e-1)} = (C, S_{w-1..1}^{(e-1)})$ 
11:   else
12:     for  $j = 1$  to  $e - 1$  do
13:        $(C, S^{(j)}) = C + x_i Y^{(j)} + S^{(j)}$ 
14:        $S^{(j-1)} = (S_0^{(j)}, S_{w-1..1}^{(j-1)})$ 
15:     $S^{(e-1)} = (C, S_{w-1..1}^{(e-1)})$ 

```

Algorithm 2.2: Multiple Word Radix-2 Montgomery Multiplication

The algorithm computes a partial sum  $S$  for each bit of  $X$ , scanning the words of  $Y$  and  $M$ . Once the precision is exhausted, another bit of  $X$  is taken, and the scan is repeated. Thus, the algorithm imposes no constraints to the precision of operands. What varies is the number of loop iterations  $e$  required to accomplish the MM operation.

By describing the MWR2MM algorithm using the VHDL language we obtain very flexible parametrizable implementation. Parameters of the algorithm:  $w$  (the word width) and  $e$  (the number of words) can be selected concerning the chosen parameter  $k$  (the length of operands), the required speed of MM operation, and the occupied area in target device.

## 2.4 High-Radix Montgomery Multiplication

Algorithm 2.3 shows the Multiple-word High-Radix ( $2^m$ ) Montgomery Multiplication algorithm (MWR2<sup>m</sup>MM) [40], a generalization of the MWR2MM algorithm (Algorithm 2.2 presented in subsection 2.3).

The parameter  $m$  changes depending on how many bits of the multiplier  $X$  are scanned during each loop, or the Radix of the computation ( $r = 2^m$ ). Each loop

iteration (computational loop) scans  $m$ -bits of  $X$  (a radix- $r$  digit  $X_i$ ) and determines the value  $q_Y$ , according to Booth encoding. Booth encoding is applied to a bit vector to reduce the complexity of multiple generation in the hardware.

```

1:  $S = 0$ 
2:  $x_{-1} = 0$ 
3: for  $i = 0$  to  $k - 1$  step  $m$  do
4:    $q_{Y_i} = \text{Booth}(x_{i+m..i-1})$ 
5:    $(C_a, S^{(0)}) = S^{(0)} + (q_{Y_i}Y)^{(0)}$ 
6:    $q_{M_i} = S_{m-1..0}^{(0)}(2^k - M_{m-1..0}^{(0)-1}) \bmod 2^m$ 
7:    $(C_b, S^{(0)}) = S^{(0)} + (q_{M_i}M)^{(0)}$ 
8:   for  $j = 1$  to  $e - 1$  do
9:      $(C_a, S^{(j)}) = C_a + S^{(j)} + (q_{Y_i}Y)^{(j)}$ 
10:     $(C_b, S^{(j)}) = C_b + S^{(j)} + (q_{M_i}M)^{(j)}$ 
11:     $S^{(j-1)} = (S_{m-1..0}^{(j)}, S_{w-1..m}^{(j-1)})$ 
12:     $C_a = C_a$  or  $C_b$ 
13:     $S^{(e-1)} = \text{sign ext}(C_a, S_{w-1..m}^{(e-1)})$ 

```

Algorithm 2.3: Multiple Word High-Radix (Radix- $2^m$ ) Montgomery Multiplication

For Radix-2 computation  $m = 1$  and  $q_{Y_j} = x_j$  are used, making the Algorithm 2.3 equivalent to the Algorithm 2.2.

The MWR $2^m$ MM algorithm offers faster computation of the MM than by using the MWR2MM. On the other hand the implementation and description in HDL is more difficult, and the requirements for area are higher. Very important task is a selection of the optimal Radix of the computation ( $r = 2^m$ ).

# Chapter 3

## Preliminaries: Software&Hardware Tools

In this chapter we describe a Nios system and utilities used during development. Also we present the features of a target PLD device and a Nios development board.

In section 3.1 we deal with Nios system, and its two main parts: a Nios processor and an Avalon Bus. For constructing the Nios system a SOPC Builder is used (see section 3.2). Special part is dedicated for description of the connection of user-defined peripherals (section 3.3). In section *Software tools* we present the main reasons for choosing programs for simulation and synthesis, and the features of used applications. The last section is about Nios development board.

### 3.1 Nios system

The Nios system showed in Figure 3.1 consists of three blocks:

1. Nios CPU
2. Peripheral Bus Module (PBM) – Avalon Bus
3. Set of peripherals

Detailed description of these blocks is mentioned in Nios documentation. Below we deal with some important details of the Nios processor and the Avalon Bus.

#### 3.1.1 Nios processor

Nios is a soft-core embedded processor from Altera, that includes a CPU optimized for programmable logic and system-on-a-programmable chip (SOPC) integration [3]. This configurable, general-purpose RISC processor can be combined with user-defined logic and programmed into an Altera PLD.

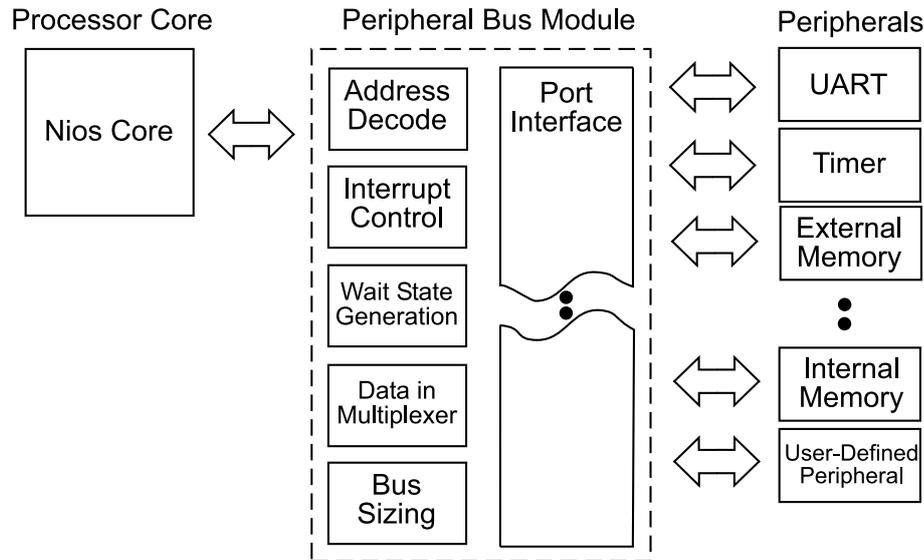


Figure 3.1: Block diagram of the Nios system

The Nios CPU can be configured for a wide range of applications. Using the SOPC Builder MegaWizard in Quartus software the parameters of the CPU, the peripherals and the whole system module can be configured for a required solution.

The Nios family of soft core processors includes 32-bit and 16-bit architecture variants. For more details about Nios CPU architecture, see Table 3.1 [3].

Table 3.1: Nios CPU architecture

Nios CPU details	Nios CPU	
	32-bit	16-bit
Data bus size (bits)	32	16
ALU width (bits)	32	16
Internal register width (bits)	32	16
Address bus size (bits)	33	17
Instruction size (bits)	16	16

### 3.1.2 Avalon Bus

An Avalon Bus included in the Nios is a parameterized interface bus used for connecting on-chip processors (Nios) and peripherals into a SOPC. Avalon is an interface that specifies the port connections between master and slave components, and specifies the timing by which these components communicate [6].

Apart from the simple wiring, the Avalon Bus module contains logic which performs these major functions:

1. Address-decoding to produce chip-select signals for each peripheral.
2. Data bus multiplexing to transfer data from a selecting peripheral to the master.
3. Wait-state generation to add extra clock-cycles to read- and write-accesses, when required by the target peripheral.
4. Dynamic bus sizing to automatically execute multiple bus-cycles as required to fetch (or store) wide data values from (to) narrow peripherals.
5. Interrupt Number Assignment to present the correct, prioritized IRQ number to the master when one or more peripherals is currently requesting an interrupt.

The Avalon Bus offers a variety of options to tailor the bus-signals and timing for different types of peripherals. In the case when wide master accessing a narrow slave port two approaches are available:

**Native address alignment** A single transfer on the master port corresponds to one transfer on the slave port, i.e. when a 32-bit master reads from a 16-bit slave port, the Avalon Bus returns a 32-bit unit of data, but only the least significant 16 bits contain valid data. The MSBs may be zero or undefined.

**Dynamic bus sizing** When a master reads from a slave port, while the master's wait-request input is asserted, the bus-logic executes so many read transfers as required to fill the master data width.

## 3.2 SOPC Builder

SOPC Builder is used to construct embedded microprocessor systems that include CPUs, memories, and I/O peripherals [10].

SOPC Builder consists of two substantially separate parts:

1. A graphical user interface (GUI) for listing and arranging system components. Within the GUI, each component may also, itself, provide a graphical user interface for its own configuration. The GUI creates a description of the system called *the system peripheral template file (PTF)*.
2. A generator-program that converts the system description (PTF file) into its hardware implementation. The generator program (among other tasks) creates an HDL (Hardware Description Language) description of the system and then synthesizes it for the selected target device.

In the first part we can add or remove the components of system, edit parameters of the Nios CPU, and the peripherals (e.g. value of registers number, base address, IRQ number...). All these settings can be done directly in any text editor by editing the system PTF file.

In the second part following tasks are performed:

- Software files (header files, libraries) stored in *project\_name\_sdk* directory are created.
- Every component's individual generator program is run, for example, to create an HDL description of the component. If no generator program is set, the *Default generator program* performs simple copying HDL-files into the project directory and arranging that component will be synthesized along with the rest of the Nios SOPC module.
- The system-level HDL file is generated (in either VHDL or Verilog).
- The entire system module and all its component are synthesized using Altera version of LeonardoSpectrum. The result is an EDIF<sup>1</sup>-file ready for place-and-route or as a module in a larger design.

When a new Nios system is going to be constructed the first step after the Quartus project creating is running the SOPC Builder as Megawizard function [7]. In GUI we set parameters of the system.

The SOPC Builder generator program can be run in GUI or from the command line using a PERL script named *generate\_project*. The name of the project is provided as a command-line argument.

### 3.3 Interfacing user-defined peripheral to SOPC builder

When building a system using the SOPC Builder, modules from two sources can be added:

1. Predefined modules delivered with SOPC builder, which are installed in the SOPC Builder library (UART, timer, PIO...).
2. User-defined modules.

All valid library components are recognized by the presence of a file named *class.ptf* stored in component's directory. This file declares and defines all the information about that component: formal name of a component, a description of

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<sup>1</sup>An industry-standard format for the transmission of design data.

its ports, a complete declaration of all I/O ports on the component, a description of GUI for configuring the component etc (for more details see section 3.3.1).

A component's library directory may also contain the logic that implement the component, the software libraries, documentation and any other component-specific information.

There are three broad mechanisms for using an SOPC Builder system module with user-defined logic [10]:

**Simple PIO connection:** The PIO's input- and output-pins will appear as I/O ports at the top level module. After other logic is connected to these pins, the system-module software can directly control logic level on each pin.

**Instatiation inside the system module:** A block of user-logic can be incorporated by instantiating it directly within the system module. SOPC Builder will create bus-logic and connect it to all bus-ports on the user-designed block. All I/O pins not designated as bus-connections will be promoted to the top level, and appear as I/O pins on the system module.

**Bus interface to external logic:** SOPC Builder can add a set of bus-interface pins customized to fit an external logic block. The bus interface includes address, data, and control signals (including decoded device-select) suitable for direct connection to a bus-interface on the device.

### 3.3.1 PTF File

SOPC Builder uses a system PTF file as a database to store information about an SOPC System – master, sets of peripherals and Avalon Bus module. In principle, to recreate a system module is possible by given only its system PTF file (and all the necessary components in the library).

Each system PTF file contains a *SYSTEM* section with exactly one section of type *WIZARD\_SCRIPT\_ARGUMENTS* and an arbitrary number of *MODULE*-type sections [13].

*WIZARD\_SCRIPT\_ARGUMENTS* section describes global system-wide settings (like the system input clock frequency and the target device for synthesis).

The content of *MODULE*-type sections is initially taken from a module's definition in the library. A section of a module's *class.ptf* file is copied into the new *MODULE* section in the system's PTF file.

#### Component's PTF

Each component's *class.ptf* file includes following parts [15]:

**ASSOCIATED\_FILES:** Describes programs which the SOPC Builder runs when component is added (e.g. Java MegaWizard) in a SOPC system and a generator program's name.

**DEFAULT\_GENERATOR:** Sets a top-level module of the peripheral, and a selection, if user-defined logic should be synthesized along with the rest of the system or will be incorporated as a black-box defined by EDIF-file can be done in this part of PTF file.

**USER\_INTERFACE:** Specifies a text that will be shown up in SOPC builder's peripheral list.

**MODULE\_DEFAULTS:** Contains important facts about I/O ports, their names, widths and directions, and parameters *avalon\_role*, that tell the SOPC Builder how ports are to be connected to an Avalon bus. In addition gives a summary information about connecting module (e.g. address alignment, number of wait states...).

The most important part of component's PTF file is the *MODULE\_DEFAULTS* part. In this part designer sets the parameters and signals of an interface between the master and the slave and defines the conditions of a communication between these two parts of SOPC system.

## 3.4 Software tools

### 3.4.1 Quartus

The Quartus II ver. 1.1 development software provides a complete design environment. The Quartus software offers a spectrum of logic design capabilities:

- Design entry using schematics, block diagrams, AHDL, VHDL, and Verilog HDL
- Floorplan editing
- Powerful logic synthesis
- Functional and timing simulation
- Timing analysis
- Software source file importing, creation, and linking to produce programming (configuration) files
- Combined compilation and software projects
- Automatic error location
- Device programming and verification

During our work the Quartus software has been applied for two important tasks: a creation and a maintenance of the Nios system using the SOPC Builder and the second operation is Place&Route, where a file for configuring Altera devices and information about timing and area occupation have been obtained. For simulation and synthesis the ModelSim and LeonardoSpectrum software tools with better features have been used.

### 3.4.2 ModelSim

As a simulation tool ModelSim PE ver. 5.5e has been chosen. This program is widely used and in addition the Nios vendor Altera recommends ModelSim for Nios simulation. Altera offers a good support for work with ModelSim: Altera devices' description and simulation files for Library of Parameterized Modules (LPM) are available for ModelSim.

#### Testbench

Testbenches have become the standard method to verify high-level language designs. Testbenches perform the following tasks:

- Instantiate the design under test (DUT)
- Stimulate the DUT by applying test vectors to the model
- Optionally compare actual results to expected results

Testbenches can be written in VHDL [11][28] or in Verilog. Since they are used for simulation only, all behavioral constructs can be used. Testbenches can be written more generically, making them easier to maintain.

For the DUT stimulating input values are needed. Since they are usually stored in text file, a conversion from string to obtain *std\_logic\_vector* is needed. In addition the values can be stored in hexadecimal notation, when another conversion is required [18].

After the output values are obtained, they can be compared to the expected results. It is done by comparison the text files with actual and expected values. Second method is the waveform comparison and the third commonly used method is self-testing testbench [29].

### 3.4.3 LeonardoSpectrum

For synthesis the LeonardoSpectrum v2001.1 is used for the similar reasons as ModelSim for simulation. This tool is very popular and offers very powerful features for synthesis.

The tool suite can be configured in three different levels of capability [24]:

**Level 1** produces the basic netlist. After input design files and technology are selected, and optionally global timing constraints are set, a netlist is produced. Special Altera version of the Level 1 is applied to crypted design files' synthesis.

**Level 2** adds more design capabilities (e.g. hierarchy preservation, advanced constraints etc.).

**Level 3** supports scripts writing and running. Incremental optimization is possible, what means, that a design is optimized at first, and a netlist is generated in the next step, what is in contrast to Levels 1 and 2, where a netlist after each optimization is created. In addition an Altera TimeCloser<sup>2</sup> simulation flow is supported.

### 3.4.4 GNUPro Software Development Tool

The software part of development is powered by GNUPro, a RedHat company. The GNUPro Toolkit is an industry-standard open-source software development toolkit optimized for the Nios embedded processor [36]. The toolkit includes a C/C++ compiler, macro-assembler, linker, simulator, debugger and numerous binary utilities, and libraries.

Two programs from GNUPro have been utilized *nios-build* and *nios-run*. The first one compiles, assembles, and links Nios source code. The output file with the suffix *.srec*, is ready for downloading to the GERMS monitor running on the Nios development board.

The *nios-run* downloads code to Nios development board and perform terminal I/O.

## 3.5 Development board

During development and testing period a Nios development board [2] has been used. The kit is provided by Altera together with software needed for development.

The board contains an APEX20K200EFC484-2X device, two 1 Mbit (64k × 16) SRAM devices and one 8 Mbit (512k × 16) of flash memory device, RS-232 serial port, JTAG connector and others components.

### 3.5.1 GERMS monitor

The GERMS monitor [4] is a simple monitor program that provides basic development facilities for the Nios development board. GERMS is a mnemonic for the minimal command set of the monitor program included in the Nios development kit (see Table 3.2).

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<sup>2</sup>The Altera TimeCloser flow is a two-pass synthesis flow where actual routing delays from a first-pass place and route are used as the timing data for a second-pass optimization (see [23]).

Table 3.2: GERMS monitor commands

Syntax	Description
<b>G</b> <base address>	Go (run a program)
<b>E</b> <base address>	Erase flash
<b>R</b> <base address>-<base address>	Relocate next download
<b>M</b> <address>	Memory set and dump
<b>S</b> <S-record data>	Send S-records
<b>:</b> <I-hex record data>	Send I-Hex records
<CR>	Display the next 64 bytes of memory
<ESC>	Restart the monitor

### 3.5.2 APEX 20K200EFC484-2X device

Elementary device features are written in Table 3.3 [1]. A useful Nios system module (CPU and peripherals) typically occupies between 25% and 35% of the logic on this device.

Table 3.3: APEX20K200E device features

Maximum System Gates	525,824
LEs	8320
ESBs	52
Maximum RAM bits	106,496

#### Embedded System Block

To store a data in memory or for CPU registers implementation Embedded System Blocks (ESBs) are used [5].

The ESB can implement various types of memory blocks, including dual-port RAM, ROM etc. The ESB includes input and output registers. The input registers synchronize writes, and the output registers can pipeline designs to improve system performance. The ESB offers a dual-port mode, which supports simultaneous reads and writes at two different clock frequencies (see Fig. 3.2).

When implementing memory, each ESB can be configured in one of the following sizes:  $128 \times 16$ ,  $256 \times 8$ ,  $512 \times 4$ ,  $1024 \times 2$ , or  $2048 \times 1$ . By combining multiple ESBs, larger memory blocks can be implemented. Memory performance does not degrade for memory block up to 2048 words deep.

The ESB implements two forms of dual-port memory: read/write clock mode and input/output clock mode.

The read/write clock mode contains two clocks. One clock controls all registers associated with writing: data input, WE, and write address. The other clock controls

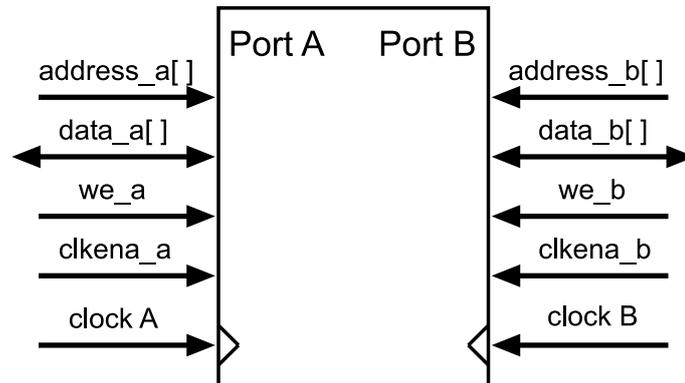


Figure 3.2: APEX 20K ESB Implementing Dual-Port RAM

all registers associated with reading: read enable (RE), read address, and data output.

The input/output clock mode contains two clocks too. One clock controls all registers for inputs into the ESB: data input, WE, RE, read address, and write address. The other clock controls the ESB data output registers.

# Chapter 4

## Radix-2 Coprocessor Implementation

In this chapter we describe the MM coprocessor implementation. We explain a function of selected parts of the coprocessor and design considerations.

### 4.1 Design considerations

#### 4.1.1 MM coprocessor

The main features of multiplier implemented in presented MM coprocessor are:

1. The ability to work on several operand precision.
2. The capability to be adjustable to PLD with different capacity.
3. A use a pipelined organization that reduces the impact on signal loads as a result of high precision of the operands.

The ability to handle long-precision numbers with small precision operations has been done using conventional multipliers, and a control algorithm that uses these multipliers.

The second feature comes from the flexibility of the algorithm and hardware to be adjusted in both word size and number of processing elements.

The high load on signals broadcast to several hardware components is an important factor to slow down high-precision Montgomery multiplier designs. For this reason, the use of systolic structures have been considered by other researchers [12]. The organization of multiplier presented in this thesis is not purely systolic, and has a flavour of serial-parallel implementation of the multiplication algorithm.

Structure of presented MM coprocessor is based on designs presented in [25] and [19]. The coprocessor has been split in into two blocks: a multiplier block and memory block (see Fig. 4.1).

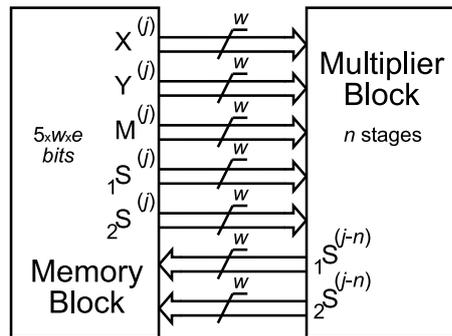


Figure 4.1: Block diagram of MM coprocessor

A requirement to develop a pipelined version of the MM coprocessor has been given during working. Design 1 described in section 4.2.1 is based on the version presented in [19], the structure of basic MM unit is preserved. In Design 2 (section 4.2.1) the output pipeline registers of the MM unit are removed as well as the registers between the stages to achieve lower area occupation.

#### 4.1.2 Interface

Many decisions have been made during the development the interface between the MM coprocessor and the Nios processor. In the next part interface-signals are described, and the reasons for choosing their parameters are discussed.

The Figure 4.2 shows the signals used for communication between the MM coprocessor and the Nios processor.

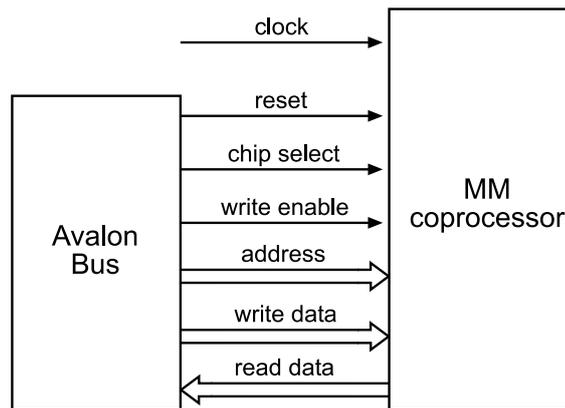


Figure 4.2: Block diagram of the interface between the MM coprocessor and the Nios processor

### Clock signal

In general, a peripheral connected to processor is wired to the same clock signal as the processor. In our case, the MM coprocessor is able to run on higher clock frequency as the master – Nios processor. Therefore we have used the possibility to promote a signal of instantiated peripheral to the top level. It means that the Nios system block has two separated input pins for clock signals: the first pin is dedicated for the Nios processor's clock, and the second one for the MM processor's clock.

### Data signals

The width of input and output data signals are equal to the word width  $w$  in the MM coprocessor. Thanks to dynamic address alignment (see section 4.1.3) from the Nios' point of view is the data width equal to the inner data bus, i.e. 16 bits for the 16-bit Nios and 32 bits for the 32-bit Nios. The value of data width is the only interface parameter that is different for Nios 16- and 32-bit.

### Address signal

The way how are data in the coprocessor mapped in its memory is described in part 4.4. The width of address signal varies in dependency on the version of implemented coprocessor, according to the number of words  $e$ .

### Other signals

Three additional signals are used in the interface:

**Reset signal** is provided for all peripherals of the Nios system.

**Chip select signal** is used by the write process. Input data are stored only when *chip select* signal is active.

**Write enable signal** is in combination with the *chip select* signal used to control the correct data storing to the memory. The signal indicates that the current bus transaction is a write-data operation.

## 4.1.3 Address alignment

In section 3.1.2 two different modes of the address alignment are described. The *dynamic* alignment has been chosen. Below are two main reasons for dynamic alignment selection:

- it enables the Nios to perform data transfers as if the coprocessor have been always the same width as the processor.

- it simplifies software design for the Nios, by eliminating the need for software to splice together data from the coprocessor.

There is no way for the 32-bit wide processor to read from only 16-bit location in the coprocessor, but this disadvantage of dynamic memory alignment is not important in our case. All operations in the processor are computed with full data width.

## 4.2 Multiplier block

The crucial block of the MM coprocessor is a multiplier block which is based on the version presented in [19], a unit realizing inner part of the main loop in Algorithm 2.2. Block provides control for basic MM units, and manages a data exchange with a memory block.

To fulfil these aims, the block contains logic for:

- generating read and write addresses and write enable signal for memories
- counting number of the cycles, the words and the bits in the word
- generating all other supporting signals for basic multiplication unit

A word width  $w$ , number of words  $e$ , and number of stages  $n$  are values, that can be set as a parameter with arbitrary value with limitations given by target device and/or by chosen control structure of the coprocessor.

In order to reduce storage and arithmetic hardware complexity, data path of MM coprocessor uses  $X$ ,  $Y$  and  $M$  in a standard non-redundant form. The internal sum  $S$  is received and generated in the redundant Carry-Save form [31]. Therefore the bit resolution of the sum  $S$  is effectively doubled.

Each MM unit propagates the words  $Y$  and  $M$  and the newly computed words of  ${}_1S$  and  ${}_2S$  to the next MM unit, which performs another computational loop of the MM algorithm and on its turn propagates the words of  $Y$  and  $M$  and the newly computed words of  ${}_1S$  and  ${}_2S$ , with a latency of 3 cycles (Design 1) or 2 cycles (Design 2).

The first stage gets data from memory and the results propagates to the next stage, the last stage stores data to the memory. When only one stage is implemented, data are directly stored to the memory.

In the next part two similar design are presented. In Design 1 the MM unit design from the previous implementation [19] is preserved. In Design 2 we have removed the output pipeline register, and afterwards also the registers between the stages. Comparison of both solutions is presented in section 6.

### 4.2.1 Design 1

The data path is organized as a pipeline of MM units (see detailed description in section 4.2.4) separated by registers (Fig. 4.3). A stage consists of a MM unit and a register. The MM unit implements one iteration of the inner loop in the MWR2MM algorithm (Algorithm 2.2 in section 2.3). Each stage gets as inputs one word of  $Y$ ,  $M$ ,  ${}_1S$  and  ${}_2S$  each clock cycle. Depending on the computations progress, one bit of  $X$  is loaded in a different stage every 3 clock cycles.

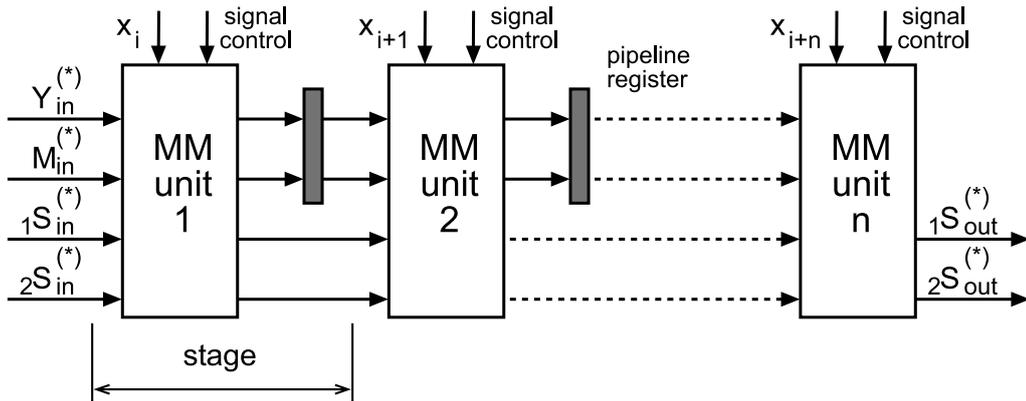


Figure 4.3: Block diagram of multiplier data path

### 4.2.2 Design 2

The output pipeline registers in the MM unit and the registers between the stages have been removed in this version. The results are directly propagated to the next stage or are stored to the memory in case with one stage.

The motivation for developing of this version is in a possibility to obtain the design with lower area occupation.

### 4.2.3 Parallel computation

In previous work [19] the only one MM unit was used, our aim was to implement solution, where the parallelism of algorithm is utilized. Short analysis of data dependencies [39] shows that the degree of pipelining and parallelism can be very high.

The dependency between operations within the loop for  $j$  restricts their parallel execution due to dependency on the carry –  $c$ . However, parallelism is possible among instructions in different  $i$  loops. Results from one MM unit are not stored in the memory, but may be passed to the next MM unit.

The maximum degree of pipeline that can be attained with this organization is found as

$$p_{max} = \left\lceil \frac{e}{x} \right\rceil \quad x = \begin{cases} 3 & \text{for Design 1} \\ 2 & \text{for Design 2} \end{cases} \quad (4.1)$$

To preserve not too much complicated control structure of coprocessor, use of  $n$ , where  $n \mid e$  (i.e. for  $e = 32$ ,  $n \in \{1, 2, 4 \dots\}$ ), stages is only possible. The second limitation is the width of word  $w$ , in presented version of the coprocessor  $n \leq w$  has to be fulfilled. When less than  $p_{max}$  stages are available, the total execution time will increase, but it is still possible to perform the full precision computation with smaller circuit.

The total computation time  $T$  (in clock cycles) when  $n \leq p_{max}$  modules (stages) are used in the pipeline is

$$T = e \frac{we}{n} + xn = \frac{k^2}{wn} + xn \quad x = \begin{cases} 3 & \text{for Design 1} \\ 2 & \text{for Design 2} \end{cases} \quad (4.2)$$

#### 4.2.4 MM unit

The design of data path is based on the structure presented in [39]. MM unit consists of two layers of carry-save adders and it is shown for  $w = 3$  in Fig. 4.4.

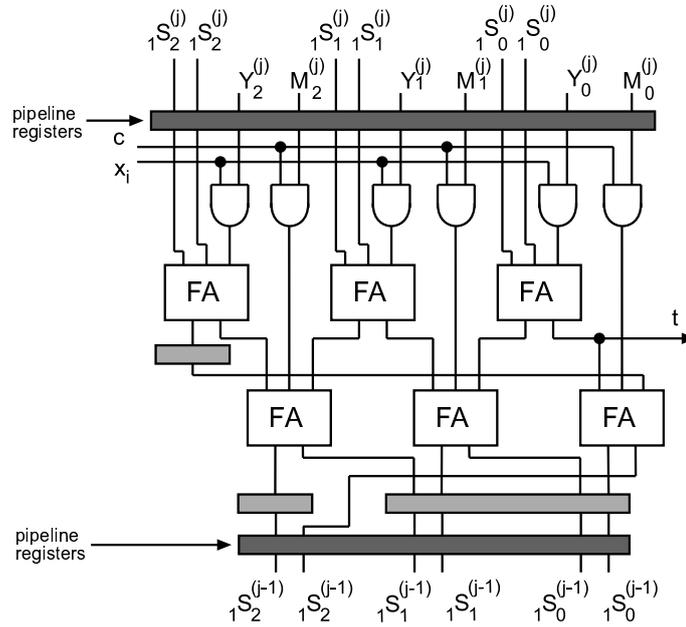


Figure 4.4: Structure of MM unit for  $w = 3$  (FA – Full Adder)

Input  $c$  represents latched value  $t^{(0)}$  that is the least significant bit of the value  $S^{(0)} + x_i Y^{(0)}$  ( $c = t^{(0)} = S_0^{(0)}$ ). This value is computed at the beginning of the main loop (when  $j = 0$ ).

While computing the word  $j$  (step  $j$  in the internal loop in algorithm 2.2, the circuit generates  $2(w - 1)$  bits of  $S^{(j)}$ , and two most significant bits of  $S^{(j-1)}$ . The bits of  $S^{(j-1)}$  computed at step  $(j - 1)$  must be delayed and concatenated with the most significant bits generated at step  $j$ . In Design 1 output data are stored in the output pipeline register.

The problem with  $S$ -value reset (step 1 in Algorithm 2.2) was solved in the previous version of the coprocessor [19], the reset signal to the input pipeline register is used (see Fig. 4.4).

Two output signals have been added – the registered values of the operands  $Y$  and  $M$  are connected to the next stage's register in Design 1 (see Fig. 4.3) or directly to the next stage. The reason why the structure is solved in this way is a delay between the moment when actual input values are present on the input and the moment when the results appear on the output of MM unit.

In the first clock cycle data are stored to the input pipeline registers. In the second cycle they are propagated to the adders, and afterwards they are presented on the output of the MM unit in Design 2 or are delayed during the next clock cycle in the output pipeline registers in Design 1. Thus, together three clock cycles delay in Design 1, and two clock cycles delay in Design 2 is between the stages, in which the same values of  $Y$  and  $M$  operands are used for computing.

#### 4.2.5 State machine

To control the multiplier's function the state machine with 4 states (wait, prepare, run, finished) is used.

The initial state is the *wait* state. In this state the block is ready for new processing. Loading or storing data to memories is possible.

After the input signal *start* is set, the state is changed to *prepare* state. All needed input signals of MM unit are initialized, also counters' values are set to zero. After one clock cycle the state *run* follows.

During this state the computation process is running. The access from the Nios processor to the memories with results  ${}_1S$  and  ${}_2S$  is forbidden.

After the value of cycle counter reaches the expected value the state is changed to *finished* and after one clock cycle back to the initial state *wait*. Afterwards next process can start.

#### 4.2.6 Memory control signals

In the multiplier block all needed signals to store data to the memory and to load data from the memory are generated.

### Data storing process

All input operands ( $X$ ,  $Y$ , and  $M$ ) have to be stored in memory before the multiplication process starts. Multiplier modifies only a content of  ${}_1S$  and  ${}_2S$  memories, where the intermediate values and final values of results are storing.

Write enable signal of  $S$  memories is active during the *run* state of the state machine. Although the output values from the last stage are not valid from the beginning, they are stored and afterwards overwritten by valid values after a write address is initialized.

The write address of  $S$  memories is derived from the word counter. When the first valid values of  $S$  operands appear on the output of the last stage, the write address is initialized.

### Data reading process

During multiplication or squaring operation the operands  $X$ ,  $Y$ ,  $M$  and  $S$  have to be read from the memory in different order.

Intermediate results stored in  $S$  memories, and operands  $Y$  and  $M$  are read every clock cycle, the read address is equal to the value of the word counter.

The multiplier  $X$  value is changed in a different order. The word of  $X$  is loaded from the memory  $X$  or  $Y$  and temporary stored in a shift register. If the squaring flag is set, the word from  $Y$  memory is read. Once the precision is exhausted, another word of  $X$  is taken. The number of cycles between two read operations depends on the number of stages and the width of word.

## 4.2.7 Counters

System of three counters control the computation process: a cycle, a word, and a bit counter. Values all of them are initialized by *start* signal. In addition the value of the word counter is set to zero, when new bit of  $X$  word is scanned, and the bit counter is initialized after the next  $X$  word is stored in the shift register.

## 4.3 Memory block

The most important parameter influencing the overall multiplier speed is the memory access time.

Since during one cycle current result from the last stage has to be written and previous result has to be read to the first stage from the same memory, we have chosen to configure the memory block as a dual port RAM. An Altera-specific function `lpm_ram_dp()` from the LPM is used. List of variables, which have to be store consists of:

- $X$  – input value, multiplier

- $Y$  – input value, multiplicand
- $M$  – input value, modulus
- ${}_1S$  and  ${}_2S$  – input/output value, intermediate and final result

Thus we operate together with five memory blocks, which are implemented in ESBs of APEX device (see details in section 3.5.2). In previous solution the sixth memory block was used as a work memory because of lack of the memory in the PIC processor.

The memory block is shared by both the Nios processor and the MM coprocessor. Therefore special attention has been paid to connection of this block in correct way. It means, that the `lpm_ram_dp()` function's parameters are set to be suitable as for the processor as well as for the coprocessor.

To achieve this goal the following procedure has been applied.

1. Vendor-defined on-chip RAM has been connected as a peripheral to the Nios processor.
2. After the project has been generated, the PTF and the Verilog<sup>1</sup> file of connected memory have been obtained. Verilog file describes the memory as the `lpm_ram_dp()` function, the PTF provides information about the interface to Nios.
3. For functional verification of implemented memory a very simple code for reading and writing to memory have been written in C language.
4. The parameters from the PTF and from the Verilog file have been utilized to create new similar files (in VHDL) with parameters of our peripheral (different size of memory...).
5. A new user-defined peripheral has been used following the procedure mentioned in SOPC Cookbook [15] by using the files generated in the previous steps.
6. After new project generation and compilation and after device programming the simple code to test connected peripheral have been run.

We consider this method as very useful and quite quick way how to find out correct connection parameters of the user-defined peripherals, which are similar to the vendor-defined peripherals.

After applying the procedure mentioned above the following parameters for `lpm_ram_dp()` function have been set in the memory block of the MM coprocessor:

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<sup>1</sup>Although the VHDL has been selected for our project all output files are in Verilog, only files for simulation are translated to VHDL by SOPC Builder.

```
LPM_INDATA           => "REGISTERED" ,
LPM_WRADDRESS_CONTROL => "REGISTERED" ,
LPM_RDADDRESS_CONTROL => "UNREGISTERED" ,
LPM_OUTDATA          => "UNREGISTERED"
```

Output data for reading are available immediately after receiving the read address therefore no additional wait state for the Nios processor is needed. Input data and write address are registered what assures error-free synchronized writing process.

## 4.4 Interface block

The third part of coprocessor represents the interface between the Nios processor and the MM coprocessor. The block is very simple thanks to features of the Avalon Bus.

Input address is already decoded by the Avalon Bus (see section 3.1.2), therefore only elementary mapping operation is required. First 3 bits of address signal indicates the memory block implemented in EMB, the remaining bits are equal to the address used within the coprocessor and represents the address of words in the coprocessor's memory.

*Write enable* and *chip select* signals control the writing process to the memory block of the coprocessor. After the address decoding, *chip select* signal of the coprocessor is asserted and *write enable* signal is active to indicate the write operation to the memory. Afterwards data from the processor presented on the write data input are valid, and can be stored to the coprocessor's memory according to the write address.

The reading process is much more easily. Data available on the read data output are read by the Nios processor only in that case when the read address of the MM coprocessor is valid. Then the Avalon Bus connects the coprocessor's data output to the Nios processor's data input using the *Data in* multiplexer (see picture 3.1).

Write enable signal for specific memory block is generated as a logical AND of input *write enable* signal and *chip select* signal and of the memory block's address.

During the development process all memory blocks have been accessible as for reading as well as for writing. This is not necessary in the final version, where the processor is able to write to  $X$ ,  $Y$  and  $M$  memory and can read from the memories  ${}_1S$  and  ${}_2S$ .

To control the coprocessor and to check its status two registers are implemented in the coprocessor as a part of the interface. The length of registers is the same as the input and output data width.

The first register is called *control register* and aims for sending simple commands to the coprocessor. In presented version only two LSB bits of register are used with next functions:

- 0. **bit** controlling the multiplication/squaring process (set 1 to run computation)
- 1. **bit** switching between the multiplication and squaring (set 0 to multiply input values, set 1 to square value stored in memory  $Y$ )

When other address than address of  ${}_1S$  or  ${}_2S$  memory is on the input of coprocessor the content of the second *status register* is presented on the data output. Only one bit (LSB) is used for the coprocessor status indication in this register. When the coprocessor is running (states *prepare* or *run*) the value of the 0.bit is 1, else 0.

## 4.5 Testing software

After the synthesis, the Place&Route procedure, and the programming the target device, a correct function of the system has been tested.

For simple reading from and writing to the coprocessor's memory the commands of the GERMS monitor have been utilized. To verify the results of the multiply operation, simple programs in C have been written. In the last step we have applied the MM coprocessor to RSA. Short description of RSA code is mentioned in the last part of this section.

Simple program for the coprocessor testing executes the following procedures:

1. Starts the timer.
2. Writes data to  $X$ ,  $Y$ , and  $M$  memories.
3. Changes the contents of the control register – starts the multiplication process.
4. Checks the status register and waits for the results.
5. Stops the timer.
6. Prints the results from the MM coprocessor, and the value of time taken for writing to the memories, and for multiplication.

For the operations with timer a function *nr\_timer\_milliseconds()* is used. Writing to the control register is solved using a function in assembler:

```

MOVI    %g0,1          ;Value for the MM control register
ST      [%i4],%g0      ;Write MM control register
NOP
MOVI    %g0,0          ;Value for control register
ST      [%i4],%g0      ;Write MM control register
NOP

```

Similarly for reading from the status register a function in assembler is used:

```
TEST:                ;Test the MM status register
    LD      %g0, [%i4] ;Load status
    SKPO   %g0, 0      ;Check if zero
    BR TEST                ;If not, jump to TEST
    NOP
```

### 4.5.1 RSA

For testing of the MM coprocessor and for obtaining the timing results of application the coprocessor to RSA the code realising the Montgomery multiplication (Algorithm 2.1) has been used. Code is prepared for 16-bit version of Nios, and executes the RSA algorithm with  $k = 1024$ -bits operands.

Precomputed input values  $R^2 \bmod M$  and  $R \bmod M$  are stored in the Nios's memory, and are not computed. The encryption time is obtained for the  $F_4$  exponent. For decryption we apply the 1024-bit exponent including 528 ones, i.e. the multiplication process is executed 528 times (step 6 in Algorithm 2.1), and the squaring process 1024 times (step 4 in Algorithm 2.1).

# Chapter 5

## Methodology

In this chapter we describe a work made during the development and testing MM coprocessor and its connection to the NIOS processor.

### 5.1 Code translation

Since all source files of previous coprocessor's implementation have been written in AHDL, the first aim has been the translation to VHDL or to Verilog language.

Both the simulation tool ModelSim and the synthesis tool LeonardoSpectrum [22] are not able to work with AHDL, programs support only designs described by VHDL or Verilog language. Because we have had some experiences with VHDL during working on other projects and the ModelSim license has been available for VHDL only, the VHDL has been selected as a language for design description.

### 5.2 Simulation

The simulation has been necessary as during the translation the source code to VHDL as well as later during the interface and control software development.

Very useful feature is a possibility to simulate the system as a whole, i.e. MM coprocessor connected to the Nios processor with the executable code stored in on-chip memory and simulated input of UART [9].

Since the system is embedded in PLD, sometimes the simulation has been the only possibility of how to verify correct function of system or to find sources of errors.

In comparison to the simulation process using Altera MaxPlus II development tool, in ModelSim all design signals' names stay preserved and can be easily added to the list of simulated signals.

Next part describes three ways how the input signals can be stimulated:

- For simple designs with small amount of signals the GUI can be used to force/unforced signals' values. All steps in GUI are translated to commands,

which are executed in command line. ModelSim commands written in text file form so called “do” file [35].

- Very often a need for using the same settings and/or values of input signals is actual. In “do” file all of ModelSim commands [34] can be stored and used for different projects.
- To make the simulation process even more comfortable a self-testing testbench – one that automates the comparison of actual to expected testbench results, can be applied. For more details see section 3.4.2 or [29], [18].

All these method can be combined to achieve a required behavior of input or internal signals of design.

Many times used feature of ModelSim simulator is a possibility to divide signals in several groups or to change a wave color. When the multiplier block was simulated, we needed to check both the I/O signals of the module and the internal and MM unit’s signals. If all signals are situated in one window, checking is difficult and is getting long-winded. To keep all signals ordered, one group of signals has been added in the wave window, afterwards new window pane has been open and the second group of signals has been added. It is a very good way how to keep a bunch of signals sorted and readable.

### 5.2.1 The MM coprocessor simulation

In the first period of the development, when particular blocks of the coprocessor has been translated to VHDL, mainly “do” files has been applied to set the initial values of input signals.

For testing the MM unit and also the multiplier block test vectors from previous project has been utilized. The results has been checked in the waveform window of simulator. After the connection of the memory block to the multiplier block, the MM coprocessor has been tested using the self-checking testbench.

The input file containing the hexadecimal values of input operands  $X$ ,  $Y$ , and  $M$ , and the expected values of result  ${}_1S$  and  ${}_2S$ , have been read by testbench. Also clock signal, *start* signal and signals controlling the write process to the memory have been generated by testbench. Afterwards, during the results storing in the memory, the values have been compared to the results written in the input file. If the values have not been the same a error message set in testbench has been quoted to the command line of the simulator.

After the features and design of the interface block has been stated, we have written another testbench file to simulate the communication between the processor and the coprocessor. In this way all output signals of the Nios processor have been generated by testbench. Also the output values have not been checked during their storing in the memory, but the read process from the processor’s memory has been simulated and values obtained from the coprocessor have been compared with correct values.

## 5.2.2 The Nios processor simulation

Before a design has been downloaded to the development board, the simulation has been executed to verify correct function of the block. Since the simulation without running program code is not useful, problem how to simulate an executable code had to be solved.

The easiest way is to store the code in the on-chip memory and run it with GERMS monitor's commands. But there is a bug in how Nios ver. 1.1.1 reads *srec* files and stores them in internal memory. Basically, the vector table is not taken into account and the first 64 words of the *srec* file are not overwritten by the vector table. We have received<sup>1</sup> a PERL script *srec2mif* that converts a SREC file into a MIF file and pads the first 64 locations of the *mif* file with 0's. During the VHDL simulation files generation process *mif* files are converted to *dat* files, and the content of all memories is initialized from *dat* directly in VHDL code.

After this correction the executable code in the on-chip memory works properly and can be started by *Gxxxx* command in GERMS monitor shell (xxxx have to be rewritten by a start address of the main program memory, in which the code is stored).

### UART input simulation

A method how the monitor's command can be simulated is quite simple. Below is showed an example of *character\_stream.dat* file stored in *project\_name\_sim* directory.

```
@0000
0A 47 31 30 30 30 0A 0D
00
```

In simulation, the Nios UART will read this file as a source of simulated character-input. This example "types" the string:

```
<LF> G1000 <CR>
```

Which is a command to the monitor telling it to start executing code at address 1000. Changes of the file have to be done before the simulation files are generated.

### Simulation flow

In the next part a simulation flow is shortly described [16]. We suppose that the Nios system project is created, the MM coprocessor is connected, and a source file with program is written.

1. Use *nios-build* script to generate executable code.

---

<sup>1</sup>This bug has been fixed by Altera applications engineer via mySupport system [14].

2. Use *srec2mif* script to convert obtained *srec* file into a *mif* file.
3. In the System Builder menu create a new on-chip ROM memory and set the generated *mif* file as a content. In the next Builder's window select new-created on-chip memory as the main program and data memory, and in the third window specify interrupt vector table location in on-chip memory. Finally generate the project and close the Quartus II.
4. Repeat steps 1 and 2 to generate the code with new libraries and header files.
5. Edit the *character\_stream.dat* file if it is necessary.
6. Use *generate\_project* script to generate the project.
7. Make a correction (add ".txt") in the *project\_name\_test\_bench.v* file at the line, where the name of the user-defined peripheral top entity's name is mentioned to

```
'include "../top_entity_name.vbb.txt"
```

and save it.

8. Run *vhdl\_simulation* script to generate the simulation files in the directory *project\_name\_sim*.

After this procedure VHDL simulation files are created and ready to be used in the simulation tool.

## 5.3 Synthesis

In many cases the LeonardoSpectrum synthesis tool has been applied.

Basically LeonardoSpectrum is used for synthesis of the Nios system by System Builder. The source code of the Nios processor is encrypted, therefore Altera version of LeonardoSpectrum Level 1 is required.

The best way of how to implement the MM coprocessor is to synthesize it along with the Nios system what is due to problem with a license<sup>2</sup> impossible. Therefore the coprocessor is connected as a *black box* component, what means that the peripheral is synthesized as a separated block and afterwards it is implemented in the Nios system.

Mostly the Level 2 has been used for synthesis of the MM coprocessor. The input design files have been selected, and the top level design has been marked. Afterwards the following optimization settings have been set:

---

<sup>2</sup>The Nios source code is written in Verilog, MM coprocessor is described by VHDL. Problem with VHDL/Verilog license is fixed only in version Nios 2.0.

- Extended optimization effort: pass 1-4
- Optimize for: Auto
- Hierarchy: Auto
- Add I/O pads: Disabled

The last item is very important. The I/O pads must not to be added, since the coprocessor is later connected to the Nios processor, and is incorporated in the Nios top-level design.

After the synthesis flow is done, the EDIF-file (*.edf*) is generated, and ready for using in the next procedure (for place-and-route or as a module in a larger design). The results presented in chapter 6 have been obtained after a Place&Route (P&R) process in Quartus II development tool.

If the obtained maximal clock frequency is not sufficient, a procedure described in [21] can be followed. In this case, the required clock frequency is given, and the LeonardoSpectrum tries to reach this value.

# Chapter 6

## Results and comparisons

Presented implementation results are generated after the synthesis in LeonardoSpectrum v2001.1 and following Place&Route procedure in Altera Quartus II, ver. 1.1 development system. Area occupation expressed in Logic Elements (LEs) and maximal possible PLD clock frequency ( $f_{clk}$ ) for Altera PLD APEX 20K200EFC484-2X are given in tables for several versions of the MM coprocessor and for selected combinations of the coprocessor's parameters: word width  $w$ , number of words  $e$ , and number of stages  $n$ . In addition tables with comparison of implemented versions are presented.

### 6.1 Design 1

In Tables 6.1-6.3 we show the results of Design 1 mapping. Description of Design 1 is given in section 4.2.1.

Table 6.1: Design 1 – Area occupation (LEs)/max  $f_{clk}$  (MHz) of the MM coprocessor ( $k = 1024$  bits)

	$w = 8$		$w = 16$		$w = 32$	
	LEs	$f_{clk}$	LEs	$f_{clk}$	LEs	$f_{clk}$
$n = 1$	281	69.98	429	70.01	776	67.14
$n = 2$	439	65.73	743	69.01	1394	62.56
$n = 4$	757	62.8	1365	70.69	2618	67.2
$n = 8$	N/A		2609	65.63	5125	66.35

Table 6.2: Design 1 – Area occupation (LEs)/max  $f_{clk}$  (MHz) of the MM coprocessor ( $k = 2048$  bits)

	$w = 8$		$w = 16$		$w = 32$	
	LEs	$f_{clk}$	LEs	$f_{clk}$	LEs	$f_{clk}$
$n = 1$	292	70.18	446	55.91	786	62.24
$n = 2$	446	65.93	752	64.64	1404	67.08
$n = 4$	765	52.44	1378	56.31	2635	57.52
$n = 8$	N/A		2619	65.45	5137	64.57

Table 6.3: Design 1 – Area occupation (LEs)/max  $f_{clk}$  (MHz) of the MM coprocessor ( $k = 4096$  bits)

	$w = 8$		$w = 16$		$w = 32$	
	LEs	$f_{clk}$	LEs	$f_{clk}$	LEs	$f_{clk}$
$n = 1$	302	68.32	455	61.64	832	59.44
$n = 2$	461	64.3	763	63.61	1413	54.92
$n = 4$	779	63.51	1386	65.41	2695	60.61
$n = 8$	N/A		2632	61.49	5151	60.41

## 6.2 Design 1a

To make possible the comparison of two types of coprocessor structure, we have changed the coprocessor design. In following design named Design 1a, the coprocessor is not split in two parts (the multiplier block, and the memory block), but in three parts (multiplier, memory, and interface block), where the interface logic is removed from the top-level design to the new-created interface block. This structure is recommended in Advanced synthesis training [21] to obtain better results of mapping.

Table 6.4: Design 1a – Area occupation (LEs)/max  $f_{clk}$  (MHz) of the MM coprocessor ( $k = 1024$  bits)

	$w = 8$		$w = 16$		$w = 32$	
	LEs	$f_{clk}$	LEs	$f_{clk}$	LEs	$f_{clk}$
$n = 1$	273	69.37	413	63.28	744	62.24
$n = 2$	429	64.11	727	62.24	1362	70.09
$n = 4$	749	65.58	1349	71.51	2586	67.64
$n = 8$	N/A		2593	64.89	5093	63.19

Table 6.5: Design 1a – Area occupation (LEs)/max  $f_{clk}$  (MHz) of the MM coprocessor ( $k = 2048$  bits)

	$w = 8$		$w = 16$		$w = 32$	
	LEs	$f_{clk}$	LEs	$f_{clk}$	LEs	$f_{clk}$
$n = 1$	284	64.6	430	63.12	754	61.93
$n = 2$	438	64.48	736	62.05	1372	67.53
$n = 4$	757	65.57	1362	71.8	2603	49.84
$n = 8$	N/A		2603	65.86	5105	65.16

Table 6.6: Design 1a – Area occupation (LEs)/max  $f_{clk}$  (MHz) of the MM coprocessor ( $k = 4096$  bits)

	$w = 8$		$w = 16$		$w = 32$	
	LEs	$f_{clk}$	LEs	$f_{clk}$	LEs	$f_{clk}$
$n = 1$	294	66.31	439	62.91	803	59.1
$n = 2$	453	62.17	747	63.55	1381	61.65
$n = 4$	771	65.81	1370	64.5	2663	60.76
$n = 8$	N/A		2616	64.04	5119	60.46

### 6.3 Comparison of Design 1 and Design 1a

In the following tables (6.7-6.9) we compare the results of mapping for Design 1 and for Design 1a. While differences in area occupation are small, and are not presented in tables, the values of maximal clock frequency are significantly different for some combinations of the coprocessor's parameters. The difference of maximal clock frequency for Design 1a and for Design 1 is expressed as

$$\Delta f_{clk} = f_{clk_{1a}} - f_{clk_1} \quad (6.1)$$

Table 6.7: Comparison of max  $f_{clk}$  (MHz) for Design 1 and Design 1a ( $k = 1024$  bits)

	$w = 8$	$w = 16$	$w = 32$
	$\Delta f_{clk}$	$\Delta f_{clk}$	$\Delta f_{clk}$
$n = 1$	-0.61	-6.73	-5.0
$n = 2$	-1.62	-6.77	+7.53
$n = 4$	-2.78	+0.82	+0.44
$n = 8$	N/A	-0.74	-3.16

Table 6.8: Comparison of max  $f_{clk}$  (MHz) for Design 1 and Design 1a ( $k = 2048$  bits)

	$w = 8$	$w = 16$	$w = 32$
	$\Delta f_{clk}$	$\Delta f_{clk}$	$\Delta f_{clk}$
$n = 1$	-5.58	+7.21	-0.31
$n = 2$	-1.47	-2.59	+0.45
$n = 4$	+13.13	+15.49	-7.68
$n = 8$	N/A	+0.41	+0.59

Table 6.9: Comparison of max  $f_{clk}$  (MHz) for Design 1 and Design 1a ( $k = 4096$  bits)

	$w = 8$	$w = 16$	$w = 32$
	$\Delta f_{clk}$	$\Delta f_{clk}$	$\Delta f_{clk}$
$n = 1$	-2.01	+1.27	-0.34
$n = 2$	-2.13	-0.06	+6.73
$n = 4$	+2.3	-0.91	+0.15
$n = 8$	N/A	+2.55	+0.05

The most important difference of clock frequency has been obtained for  $k = 2048$ , where for  $n = 4$  and  $w = 16$  the maximal frequency of Design 1a is 65.57 MHz, and frequency of Design 1 is 52.44 MHz.

We can say that for some combinations of coprocessor parameters better results have been reached when the coprocessor is split in three blocks. On the other hand for other combinations the clock frequency is lower. It means that optimal coprocessor organisation depends on chosen parameters.

## 6.4 Design 2

In Tables 6.10-6.12 the results of Design 2 mapping are presented. Description of Design 2 is given in section 4.2.2.

Table 6.10: Design 2 – Area occupation (LEs)/max  $f_{clk}$  (MHz) of the MM coprocessor ( $k = 1024$  bits)

	$w = 8$		$w = 16$		$w = 32$	
	LEs	$f_{clk}$	LEs	$f_{clk}$	LEs	$f_{clk}$
$n = 1$	264	71.28	396	62.74	711	68.46
$n = 2$	387	60.95	643	71.49	1196	61.73
$n = 4$	637	71.05	1139	60.86	2168	61.68
$n = 8$	N/A		2123	61.26	4113	61.45

Table 6.11: Design 2 – Area occupation (LEs)/max  $f_{clk}$  (MHz) of the MM coprocessor ( $k = 2048$  bits)

	$w = 8$		$w = 16$		$w = 32$	
	LEs	$f_{clk}$	LEs	$f_{clk}$	LEs	$f_{clk}$
$n = 1$	274	62.57	413	64.48	721	63.03
$n = 2$	396	62.29	655	62.88	1208	61.52
$n = 4$	648	70.81	1142	71.73	2180	61.80
$n = 8$	N/A		2135	71.55	4125	59.41

Table 6.12: Design 2 – Area occupation (LEs)/max  $f_{clk}$  (MHz) of the MM coprocessor ( $k = 4096$  bits)

	$w = 8$		$w = 16$		$w = 32$	
	LEs	$f_{clk}$	LEs	$f_{clk}$	LEs	$f_{clk}$
$n = 1$	284	69.34	422	61.82	770	57.48
$n = 2$	408	63.33	666	62.07	1159	63.35
$n = 4$	663	65.83	1159	63.35	2186	61.84
$n = 8$	N/A		2145	67.51	4138	60.45

## 6.5 Design 2a

From the same reason as for creation Design 1a we have prepared Design 2a, and in Tables 6.13-6.15 we present the results of area occupation and maximal  $f_{clk}$  of the MM coprocessor.

Table 6.13: Design 2a – Area occupation (LEs)/max  $f_{clk}$  (MHz) of the MM coprocessor ( $k = 1024$  bits)

	$w = 8$		$w = 16$		$w = 32$	
	LEs	$f_{clk}$	LEs	$f_{clk}$	LEs	$f_{clk}$
$n = 1$	256	57.24	380	61.75	679	62.67
$n = 2$	379	60.35	627	64.77	1164	62.74
$n = 4$	629	67.59	1123	71.01	2136	58.18
$n = 8$	N/A		2107	69.95	4081	64.55

Table 6.14: Design 2a – Area occupation (LEs)/max  $f_{clk}$  (MHz) of the MM coprocessor ( $k = 2048$  bits)

	$w = 8$		$w = 16$		$w = 32$	
	LEs	$f_{clk}$	LEs	$f_{clk}$	LEs	$f_{clk}$
$n = 1$	266	55.22	397	66.49	689	62.38
$n = 2$	388	64.56	639	55.07	1176	61.68
$n = 4$	640	64.61	1126	70.16	2148	61.36
$n = 8$	N/A		2119	62.03	4093	66.62

Table 6.15: Design 2a – Area occupation (LEs)/max  $f_{clk}$  (MHz) of the MM coprocessor ( $k = 4096$  bits)

	$w = 8$		$w = 16$		$w = 32$	
	LEs	$f_{clk}$	LEs	$f_{clk}$	LEs	$f_{clk}$
$n = 1$	276	68.99	406	66.46	738	54.58
$n = 2$	400	63.08	650	63.46	1190	62.85
$n = 4$	655	62.63	1143	64.23	2154	58.93
$n = 8$	N/A		2129	64.22	4106	63.72

## 6.6 Comparison of Design 2 and Design 2a

In this subsection we compare the clock frequency for Design 2 and for Design 2a (Tables 6.16-6.18). Like for comparison of Design 1 and Design 1a only differences of

clock frequency are showed, since the results of area occupation are similar for both designs. The difference of maximal clock frequency for Design 2a and for Design 2 is expressed as

$$\Delta f_{clk} = f_{clk_{2a}} - f_{clk_2} \quad (6.2)$$

Table 6.16: Comparison of max  $f_{clk}$  (MHz) for Design 2 and Design 2a ( $k = 1024$  bits)

	$w = 8$	$w = 16$	$w = 32$
	$\Delta f_{clk}$	$\Delta f_{clk}$	$\Delta f_{clk}$
$n = 1$	-14.04	-0.99	-5.79
$n = 2$	-0.6	-6.72	+1.01
$n = 4$	-3.46	+10.15	-3.5
$n = 8$	N/A	+8.69	+3.1

Table 6.17: Comparison of max  $f_{clk}$  (MHz) for Design 2 and Design 2a ( $k = 2048$  bits)

	$w = 8$	$w = 16$	$w = 32$
	$\Delta f_{clk}$	$\Delta f_{clk}$	$\Delta f_{clk}$
$n = 1$	-7.35	+2.01	-0.65
$n = 2$	+2.27	-7.81	+0.16
$n = 4$	-6.2	-1.57	-0.44
$n = 8$	N/A	-9.52	+7.21

Table 6.18: Comparison of max  $f_{clk}$  (MHz) for Design 2 and Design 2a ( $k = 4096$  bits)

	$w = 8$	$w = 16$	$w = 32$
	$\Delta f_{clk}$	$\Delta f_{clk}$	$\Delta f_{clk}$
$n = 1$	-0.35	+4.64	-2.9
$n = 2$	-0.25	+1.39	-3.64
$n = 4$	-3.2	+0.88	-2.91
$n = 8$	N/A	-3.29	+3.27

Likewise for the comparison of Designs 1 and 1a, for the comparison of Design 2 and Design 2a we can say that splitting the coprocessor in three parts, and removing logic from the top-design module does not automatically bring better results of maximal clock frequency, and this rule is not valid in general.

## 6.7 Comparison of Design 1 and Design 2

In Tables 6.19-6.21 an impact of removing the output pipeline register and the register between the stages in Design 2 is presented. The difference between the maximal clock frequencies is not so significant, but we can say that Design 2 reaches lower frequencies than Design 1, what has been expected (see [19], where by adding the pipeline registers in MM unit better results for clock frequency have been obtained.) An advantage of Design 2 is lower area occupation. For example for  $w = 32$  and  $n = 8$  more than 1000 LEs can be saved in the target device. The differences of maximal clock frequency and area occupation for Design 1a and for Design 1 are expressed as

$$\begin{aligned}\Delta f_{clk} &= f_{clk_2} - f_{clk_1} \\ \Delta LEs &= LEs_2 - LEs_1\end{aligned}\tag{6.3}$$

Table 6.19: Comparison of area occupation (LEs)/max  $f_{clk}$  (MHz) for Design 1 and Design 2 ( $k = 1024$  bits)

	$w = 8$		$w = 16$		$w = 32$	
	$\Delta LEs$	$\Delta f_{clk}$	$\Delta LEs$	$\Delta f_{clk}$	$\Delta LEs$	$\Delta f_{clk}$
$n = 1$	-17	+1.3	-33	-7.27	-62	-1.32
$n = 2$	-50	-4.78	-100	+2.48	-198	-0.83
$n = 4$	-120	+8.25	-226	-9.83	-450	-5.52
$n = 8$	N/A		-486	-4.37	-1012	-4.87

Table 6.20: Comparison of area occupation (LEs)/max  $f_{clk}$  (MHz) for Design 1 and Design 2 ( $k = 2048$  bits)

	$w = 8$		$w = 16$		$w = 32$	
	$\Delta LEs$	$\Delta f_{clk}$	$\Delta LEs$	$\Delta f_{clk}$	$\Delta LEs$	$\Delta f_{clk}$
$n = 1$	-18	-10.57	-33	+8.57	-65	+0.79
$n = 2$	-50	-3.66	-97	-1.76	-196	-5.56
$n = 4$	-117	+18.37	-236	+15.42	-455	+4.28
$n = 8$	N/A		-484	+6.1	-1012	-5.16

## 6.8 Computation time

The total computation time of MM operation  $T_{MM}$  (according to the equation 4.2) is:

$$T_{MM} = \frac{1}{f_{clk}} \frac{k^2}{wn} + xn \quad x = \begin{cases} 3 & \text{for Design 1} \\ 2 & \text{for Design 2} \end{cases}\tag{6.4}$$

Table 6.21: Comparison of area occupation (LEs)/max  $f_{clk}$  (MHz) for Design 1 and Design 2 ( $k = 4096$  bits)

	$w = 8$		$w = 16$		$w = 32$	
	$\Delta$ LEs	$\Delta f_{clk}$	$\Delta$ LEs	$\Delta f_{clk}$	$\Delta$ LEs	$\Delta f_{clk}$
$n = 1$	-18	+1.02	-33	+0.18	-65	-1.96
$n = 2$	-53	-0.97	-97	-1.54	-191	+11.77
$n = 4$	-116	+2.32	-227	-2.06	-509	-1.23
$n = 8$	N/A		-487	-6.02	-1013	+0.04

Performance of implemented MM coprocessor for word length  $w = 32$  and for Design 1 ( $x = 3$  in equation 6.4) is presented in Table 6.22 (frequency value of clock signals is identical and equal to 33.333 MHz for both the MM coprocessor and the Nios processor).

Table 6.22: Speed of MM operation for  $w = 32$ 

	1024 bits (ms)	2048 bits (ms)
$n = 1$	1.013	3.932
$n = 2$	0.492	1.966
$n = 3$	0.246	0.983
$n = 4$	0.124	0.492

## 6.9 ESB occupation

Number of ESBs required for the memory block of different configurations of the MM coprocessor is shown in Table 6.23.

Table 6.23: Number of used ESBs

precision/ word length	1024 bits	2048 bits	4096 bits
$w = 8$	4	5	10
$w = 16$	5		10
$w = 32$	10		

## 6.10 Application to RSA

For RSA operation time presented in Tables 6.24 and 6.25 is needed. The encryption time is calculated for the  $F4$  exponent ( $t = 17$ ), the decryption time is obtained for exponent with 528 ones ( $t = 1024$ , see Algorithm 2.1).

Since the results  ${}_1S$  and  ${}_2S$  are stored in the redundant Carry-Save form, the program has to add  ${}_1S$  and  ${}_2S$ , and performs the following correction of result:

$$\begin{aligned} S &= {}_1S + {}_2S \\ \text{if } S \geq M \text{ then } S &= S - M \end{aligned} \quad (6.5)$$

Table 6.24: Application to RSA: encryption and decryption for  $w = 16$ ,  $k = 1024$ ,  $f_{clk} = 33.333$  MHz

	external memory		on-chip memory	
	EncrT (ms)	DecrT (ms)	EncrT (ms)	DecrT (ms)
$n = 1$	44	3251	43	3229
$n = 2$	23	1696	23	1680
$n = 4$	13	920	12	899
$n = 8$	7	533	7	507

Table 6.25: Application to RSA: encryption and decryption for  $w = 8$ ,  $k = 1024$ ,  $f_{clk} = 33.333$  MHz

	external memory		on-chip memory	
	EncrT (ms)	DecrT (ms)	EncrT (ms)	DecrT (ms)
$n = 1$	85	6380	85	6365
$n = 2$	44	3272	44	3257
$n = 4$	23	1721	23	1705

As we can see from the tables, time needed for RSA is different for configuration with external memory, and with on-chip memory. If the executable code is stored in external memory, for every read or write instruction 4 clock cycles are required. For reading and writing from on-chip memory the instruction is executed in 2 clock cycles.

For example a difference between the times for on-chip and external memory in the case with  $w = 16$ ,  $e = 64$  and  $n = 1$  is 22 ms, what is equal to 773333 clock cycles for  $f_{clk} = 33.333$  MHz. Program for RSA application executes approximately  $5 \times e \times k = 5 \times 64 \times 1024 = 327680$  operations with memory. In the case when on-chip memory is used, 2 clock cycles for every operation are saved, i.e. about 655360 clock cycles, what is comparable to the value presented above.

## 6.11 Comparison to solution with embedded PIC processor

One of aim of this thesis is the comparison to existing implementation of RSA processor with Microchip's PIC processor [25]. Since the conception of our MM coprocessor is not the same but very similar to RSA processor including the PIC processor (RSA processor contains vector adder unit, which is not included in our implementation), presented differences in implementation results are not absolute. More attention has been paid to the comparison of ways of connection, and to the features of the processors.

Minimal Nios processor configuration for RSA application includes 16-bit CPU (128 register window, 8kB address range), 4k on-chip memory (3k data and program memory, 1k boot memory with GERMS monitor) and UART peripheral. In Table 6.26 results of this configuration mapping in 20K200EFC484-2X are shown.

Table 6.26: Occupied sources by 16-bit Nios processor

LEs (%)	1700 (20%)
ESBs (%)	26 (50%)
$f_{clk}$	40.06 MHz

Area estimations for Altera APEX device of both implementations are given in Table 6.27. In both configurations the MM unit with  $w = 32$ , and  $n = 1$  is included. For configuration with the Nios processor Design 2a has been selected due to the smallest number of LEs.

Table 6.27: Area occupation for EP20K100 device

processor	LEs	ESBs
PIC	2165	20
Nios	2404	36

From the informations in table we can say that the number of LEs is comparable, on the other hand the number of ESBs is significantly higher for configuration with the Nios processor.

Reason is, that the number of internal 8-bit registers of PIC processor can be from 8 to 32, the minimal number of Nios 16-bit registers is 128. In addition in Nios we have used GERMS monitor stored in 1k ROM memory, and UART peripheral for communication, in configuration with PIC processor a PCI is used.

By connecting the MM coprocessor to the PIC processor modifications of PIC internal registers have been needed. The coprocessor is controlled by data, address, control and status registers mapped to the PIC register area by modifying VHDL code.

By connecting the MM coprocessor to the Nios processor the standard procedure for connecting the user-defined peripherals has been used. The Avalon Bus and its features makes possible to connect the coprocessor without any changes of the Nios processor. In addition the connection by bus is more flexible (the width of connection varies in dependency on word width  $w$ ) than the connection by fixed-length internal register of PIC processor.

# Chapter 7

## Conclusion

The goals set in thesis assignment were fulfilled. The thesis presented the possibilities of connection of the MM coprocessor to the Nios embedded processor. The implemented architecture is highly flexible, the parametrizable number of stages provides possibility to prepare design suitable for a target device, with a priority in the speed or in the area occupation.

We described the methodology of the coprocessor developing, the simulation process, and the synthesis of our peripheral. Special attention was paid for description of connection the coprocessor to the Nios processor. We compared the features of implemented design to existing solution with PIC processor.

By connecting the MM coprocessor to the Nios processor we obtained very powerful system. Nios processor offers the possibility to perform more complex program code and implement more difficult computations than the PIC processor. In addition the Nios processor is still in development, and new features are added. Since the MM coprocessor's input operand precision is parametrizable, it can be utilized in several cryptography standards (e.g. ECC, RSA, DSS). There is also space for further development of the MM coprocessor by implementation of MWR2<sup>m</sup>MM algorithm.

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